

Z-PACK | Z-PACK Future Bus+

TE Internal #: 5223513-1 Board-to-Board, 24 Position, 4 Row, 6 Column, Housing for Male Terminals, Sealable, Z-PACK Future Bus+, Backplane Connector Housings

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Connectors > PCB Connectors > Backplane Connectors > Backplane Connector Housings



Connector System: Board-to-Board

Number of Positions: 24

Row-to-Row Spacing: 2 mm

Number of Rows: 4

Number of Columns: 6

Features

connectivity

Product Type Features

Connector System	Board-to-Board
Connector & Housing Type	Housing for Male Terminals
Sealable	Yes
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	24
Number of Rows	4
Number of Columns	6
Contact Features	
Contact Current Rating (Max)	1 A
Mechanical Attachment	
Connector Mounting Type	Board Mount
Housing Features	

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5223513-1

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Centerline (Pitch)	2 mm
Dimensions	
Row-to-Row Spacing	2 mm
Usage Conditions	
Operating Temperature Range	-55 – 125 °C
Operation/Application	
Circuit Application	Signal
EU RoHS Directive 2011/65/EU	
	Compliant
EU ELV Directive 2000/53/EC	Compliant Compliant
	•
EU ELV Directive 2000/53/EC	Compliant

other sources.

Solder Process Capability

Pin-in-Paste capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

5223513-1

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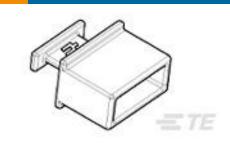
Also in the Series Z-PACK Future Bus+





Customers Also Bought









TE Part #1888247-1 20 POS SMT CONN, SFP/SFP+, 30A

TE Part #1888810-2 EMI/Dust Cover,XFP And QSFP TE Part #2170088-1 ZSFP+ Connector,30u" TE Part #5223979-2 UPM GUIDE MODULE



5223513-1

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Documents

CAD Files 3D PDF

3D

Customer View Model

ENG_CVM_CVM_5223513-1_O.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5223513-1_O.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_5223513-1_O.3d_stp.zip

English

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Product Specifications Application Specification

English

Agency Approvals UL Report

English